DATASHEET - NDRBM-16/2/D/003-F



Electronic RCD/MCB combination, 16 A, 30 mA, MCB trip characteristic: D, 2p, RCD trip characteristic: F



Part no. Catalog No. NdRBM-16/2/D/003-F 300496

Delivery program

| | | Combined RCD/MCB device, digital |
|----------------|-----------------------------------|--------------------------------------------------------|
| | | 2 pole |
| | | D |
| | | Switchgear for residential and commercial applications |
| In | А | 16 |
| $I_{\Delta N}$ | А | 0.03 |
| | | Туре F |
| | | NdRBM |
| | I _n I _{ΔN} | I _n Α Ι _{ΔΝ} Α |

Technical data

| Lieculda | | | |
|--------------------------------------|----------------|----|---------|
| Rated fault currents | $I_{\Delta n}$ | mA | 30 |
| Characteristic | | | D |
| Selectivity Class | | | 3 |
| Mechanical | | | |
| Degree of protection | | | |
| Switch | | | IP20 |
| Integrated | | | IP40 |
| Admissible ambient temperature range | | °C | -25 +40 |
| Thickness of busbar material | | mm | |
| Material thickness | | mm | 0.8 2 |
| | | | |

Design verification as per IEC/EN 61439

| Technical data for design verification | | | |
|------------------------------------------------------------------------------------------------------------------------|---|----|--------------------------------------------------------------------|
| Operating ambient temperature min. | c | °C | -25 |
| Operating ambient temperature max. | c | °C | 40 |
| IEC/EN 61439 design verification | | | |
| 10.2 Strength of materials and parts | | | |
| 10.2.2 Corrosion resistance | | | Meets the product standard's requirements. |
| 10.2.3.1 Verification of thermal stability of enclosures | | | Meets the product standard's requirements. |
| 10.2.3.2 Verification of resistance of insulating materials to normal heat | | | Meets the product standard's requirements. |
| 10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects | | | Meets the product standard's requirements. |
| 10.2.4 Resistance to ultra-violet (UV) radiation | | | Meets the product standard's requirements. |
| 10.2.5 Lifting | | | Does not apply, since the entire switchgear needs to be evaluated. |
| 10.2.6 Mechanical impact | | | Does not apply, since the entire switchgear needs to be evaluated. |
| 10.2.7 Inscriptions | | | Meets the product standard's requirements. |
| 10.3 Degree of protection of ASSEMBLIES | | | Does not apply, since the entire switchgear needs to be evaluated. |
| 10.4 Clearances and creepage distances | | | Meets the product standard's requirements. |
| 10.5 Protection against electric shock | | | Does not apply, since the entire switchgear needs to be evaluated. |
| 10.6 Incorporation of switching devices and components | | | Does not apply, since the entire switchgear needs to be evaluated. |
| 10.7 Internal electrical circuits and connections | | | Is the panel builder's responsibility. |
| 10.8 Connections for external conductors | | | Is the panel builder's responsibility. |
| 10.9 Insulation properties | | | |
| 10.9.2 Power-frequency electric strength | | | Is the panel builder's responsibility. |
| 10.9.3 Impulse withstand voltage | | | Is the panel builder's responsibility. |
| 10.9.4 Testing of enclosures made of insulating material | | | Is the panel builder's responsibility. |

| 10.10 Temperature rise | The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. |
|-------------------------------------|----------------------------------------------------------------------------------------------------------------------------------|
| 10.11 Short-circuit rating | Is the panel builder's responsibility. The specifications for the switchgear must be observed. |
| 10.12 Electromagnetic compatibility | Is the panel builder's responsibility. The specifications for the switchgear must be observed. |
| 10.13 Mechanical function | The device meets the requirements, provided the information in the instruction leaflet (IL) is observed. |